# 507047663 12/28/2021

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 EPAS ID: PAT7094501 Stylesheet Version v1.2

 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date		
SAMUEL YIN	12/21/2021		
JUI-CHEN WANG	12/21/2021		
JHIH-SYUAN CHEN	12/21/2021		

## **RECEIVING PARTY DATA**

Name:	RUENTEX ENGINEERING AND CONSTRUCTION CO., LTD.
Street Address:	10F., NO. 308, SEC. 2, BADE ROAD
Internal Address:	JHONGSHAN DISTRICT
City:	TAIPEI CITY
State/Country:	TAIWAN
Postal Code:	104

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17563138

## **CORRESPONDENCE DATA**

**Fax Number:** (202)754-9829

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 202-780-8368

Email: MAIL@MARQUEZIPLAW.COM

Correspondent Name: JUAN CARLOS A. MARQUEZ MARQUEZ INTELLECT

Address Line 1: 1629 K STREET, NW

Address Line 2: SUITE 300

Address Line 4: WASHINGTON, D.C. 20006

ATTORNEY DOCKET NUMBER:	LEEL-0184
NAME OF SUBMITTER:	JUAN CARLOS A. MARQUEZ
SIGNATURE:	/juan.carlos.a.marquez/
DATE SIGNED:	12/28/2021

**Total Attachments: 2** 

source=LEEL-184-Assignment#page1.tif source=LEEL-184-Assignment#page2.tif

PATENT 507047663 REEL: 058486 FRAME: 0903

#### ASSIGNMENT

WHEREAS, I/We, whose names and post office addresses appear below hereinafter referred to as ASSIGNOR, have invented certain new and useful improvements in BEAM-COLUMN JOINT STRUCTURE (hereinafter referred to as THE INVENTION) which I/We made, contributed to the making and/or authorized the making of an application for the above-noted subject matter which is claimed and for which a patent is sought on the invention (design, if applicable) and I/We believe that I/We are the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a United States Letters Patent is sought on the invention (design, if applicable);

Ţ	WHEREAS,	an applicat	ion for `	United	States	Letters	Patent	or for	priority	under	International	Convention
for the ab	ove-noted si	ubject matte	er is beir	ng filed	concu	rrently 1	herewit.	h, or v	vas filed	l on		,
under Ap	plication Nu	mber				;						

WHEREAS, RUENTEX ENGINEERING & CONSTRUCTION CO., LTD., whose post office address is 10F, NO. 308, SEC. 2, BADE ROAD, JHONGSHAN DISTRICT, TAIPEI CITY, 104, TAIWAN, R.O.C. (hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire right, title and interest in and to the same in the United States and throughout the world;

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, we, ASSIGNOR, by these presents do sell, assign and transfer until said ASSIGNEE, the entire right, title and interest in and to said invention and application throughout the United States of America, including any and all United States Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application; and the entire right, title and interest in and to said invention throughout the world, including the right to apply for patents and inventor certificates in respect thereof and to claim priority pursuant to rights accorded ASSIGNOR under the terms of the Paris International Convention and all other available international conventions and treaties; and the entire right, title and interest in and to any and all patents, patents of addition, utility models, patents of importation, revalidation patents and inventor certificates which may be granted throughout the world in respect of said invention.

ALSO, ASSIGNOR here by agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) or inventor certificate(s) in the United States and in foreign countries for said invention, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said invention, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the invention that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent referred to above to ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behalf; and for the use and behalf of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

PATENT REEL: 058486 FRAME: 0904 Assignment Assignor Signatures Page 2

ASSIGNOR hereby declares that all statements made herein of my/our own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine, or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

NAME: Samuel YIN

ADDRESS: 10F, NO. 308, SEC. 2, BADE RD.

Jhongshan District

Taipei City, 104, Taiwan, R.O.C.

NAME: Jui-Chen WANG

ADDRESS: 10F, NO. 308, SEC. 2, BADE RD.

Jhongshan District

Taipei City, 104, Taiwan, R.O.C.

NAME: Jhih-Syuan CHEN

ADDRESS: 10F, NO. 308, SEC. 2, BADE RD.

Jhongshan District

Taipei City, 104, Taiwan, R.O.C.

gnature 7114

Date /et, 2 , 202

Signature

Data

JANA Syuar CHE

Signature

Date

PATENT REEL: 058486 FRAME: 0905

**RECORDED: 12/28/2021**